PIN Photodiodes Panasonic

Part number notation

The part number noten on the following pages is a conventional part number.

The new Matsushita global number is:

PNZ312DN

PN312D(N)

Silicon PIN Dual Photodiode

For optical information systems

Features

• Fast response : t_r , $t_f = 10$ ns (typ.)

• Good photo current linearity

• Low dark current : $I_D = 20 \text{ nA (max.)}$

• Small size plastic package (flat type)

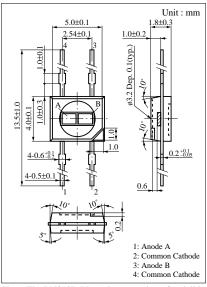
• Adoption of visible light cutoff resin

Applications

- Auto focus sensor for still cameras and video cameras etc.
- Distance measuring systems
- Position sensor for automatic assembly lines
- Eye sensor for industrial robots

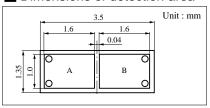
Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

Parameter	Symbol	Ratings	Unit	
Reverse voltage (DC)	V_R	30	V	
Power dissipation	P_{D}	30	mW	
Operating ambient temperature	Topr	-25 to +85	°C	
Storage temperature	T _{stg}	-30 to +100	°C	



Note) The PN312D(N) package consists of a visible light cutoff resin. Therefore the chips (A and B) shown in the drawing cannot actually be seen.

Dimensions of detection area

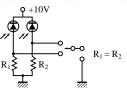


■ Electro-Optical Characteristics (Ta = 25°C)

Parameter	Symbol	Conditions	min	typ	max	Unit
Reverse voltage (DC)	V _R	$I_R = 10\mu A$	30			V
Dark current	I_D	$V_R = 10V$			20	nA
Photo current	I_L^{*3}	$V_R = 10V, L = 1000 lx^{*1}$	8	12		μΑ
Peak sensitivity wavelength	$\lambda_{ m P}$	$V_R = 10V$		940		nm
Response time	t_r, t_f^{*2}	$V_R = 10V, R_L = 1k\Omega$		10		ns
Capacitance between pins	C _t	$V_R = 10V$, $f = 1MHz$		5		pF
Acceptance half angle	θ	Measured from the optical axis to the half power point		65		deg.

Note) The indicated values for absolute maximum ratings and electro-optical characteristics are the values corresponding to individual elements.

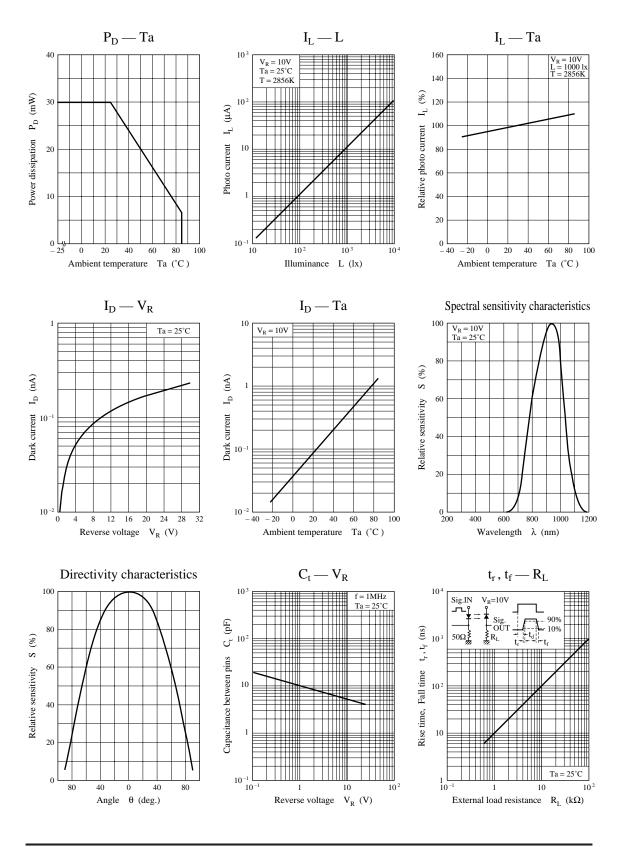
^{*3} Photo current measurement circuit



^{*1} Measurements were made using a white tungsten lamp (color temperature T = 2856K) as a light source.

^{*2} Semiconductor laser light source ($\lambda = 800 \text{ nm}$)

PIN Photodiodes PN312D(N)



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